DECLARATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name; that

I verily believe I am the original, first and sole inventor (if only one name is listed below) or a joint inventor (if plural inventors are named below) of the invention entitled:

METHOD FOR MAKING SEMICONDUCTOR DEVICES HAVING GRADUAL SLOPE CONTACTS, described and claimed

X	ın	tne	attached	spec	ricati	Lon;			
	in	the	specifica	ation	filed				
			Applicat			No.		and	as
	ann	J114CC	· ———				• •		

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims as filed and as amended by any amendment referred to above. -

I acknowledge the duty to disclose to the Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, §1.56(a).

I further declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under §1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Full name of sole or first Inventor: Sanh Dang Tang

Inventor's signature_

Date: 01-25-98

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Post Office Address: c/o Micron Technology, Inc. 8000 S. Federal Way

Boise, ID 83706-9632

POWER OF ATTORNEY

Applicant: Sanh Dang Tang	
Application No.:	Filed:
Entitled: METHOD FOR MA	KING SEMICONDUCTOR DEVICES HAVING GRADUAL
SLOPE CONTACTS	
CF	ERTIFICATE UNDER 37 CFR 3.73(b)
at 8000 S. Federal Way, Boise,	c., a corporation of the State of Delaware, with a place of busines, ID 83706-9632 certifies that it is the assignee of the entire right, application identified above by virtue of either:
A. [X] An assignment from the which is attached.	e inventor(s) of the patent application identified above, a copy of
OR	•
B. [] A chain of title from the current assignee as shown bel	inventor(s), of the patent application identified above, to the low:
1. From:	To:
	orded in the Patent and Trademark Office at, or for which a copy thereof is attached.
2. From:	To:
	orded in the Patent and Trademark Office at, or for which a copy thereof is attached.
3. From:	To:
	orded in the Patent and Trademark Office at
Reel Frame	_, or for which a copy thereof is attached.
[] Additional docume	nts in the chain of title are listed on a supplemental sheet.
[] Copies of assignments or o	other documents in the chain of title are attached.
	all the documents in the chain of title of the patent application st of undersigned's knowledge and belief, title is in the assignee

The undersigned (whose title is supplied below) is empowered to sign this certificate on behalf of the assignee.

Micron Technology, Inc. hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

Richard A. Killworth	Reg. No. 26,397
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Micron Technology, Inc. hereby declares that all statements made herein of my own knowledge are true, and that all statements made on information and belief are believed to be true; and further, that these statements are made with the knowledge that willful false statements, and the like so made, are punishable by fine or imprisonment, or both, under Section 1001, Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date:
Name: Michael L. Grack
Title: Chex Patt Court
Signature: 227